2SA2084

Silicon PNP epitaxial planar type

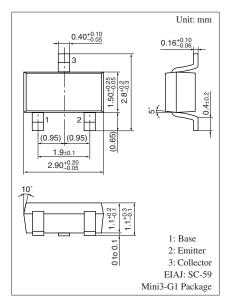
For general amplification

Features

- High collector-emitter voltage (Base open) V_{CEO}
- Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing

ADSolute Maximum Ratings $T_a = 25$ C					
Parameter	Symbol	Rating	Unit		
Collector-base voltage (Emitter open)	V _{CBO}	-300	V		
Collector-emitter voltage (Base open)	V _{CEO}	-300	V		
Emitter-base voltage (Collector open)	V _{EBO}	-5	V		
Collector current	I _C	-70	mA		
Peak collector current	I _{CP}	-100	mA		
Collector power dissipation	P _C	200	mW		
Junction temperature	Tj	150	°C		
Storage temperature	T _{stg}	-55 to +150	°C		

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: 7N

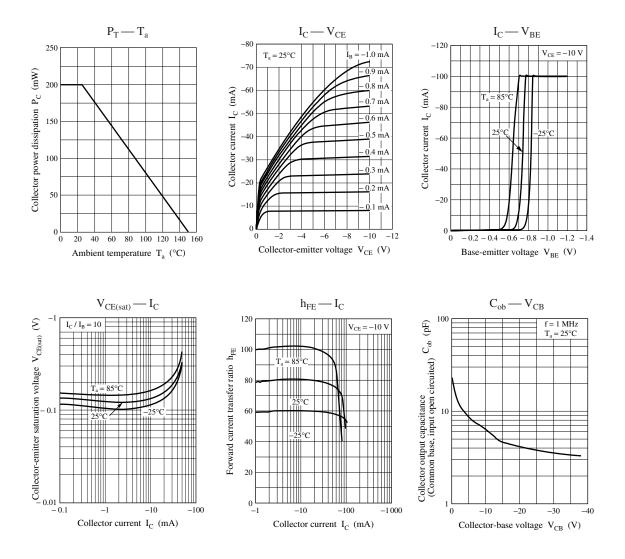
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_{C} = -100 \ \mu A, \ I_{B} = 0$	-300			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E}{=}{-}1~\mu A,$, $I_{\rm C}{=}0$	-5			V
Forward current transfer ratio *	h _{FE}	$V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$	30		150	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -1 \text{ mA}$			- 0.6	V
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		7		pF
Transition frequency	f _T	$V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$		50		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. *: Rank classification

Rank	Р	Q
h _{FE}	30 to 100	60 to 150

Panasonic



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